



N-Channel Reduced Q_g, Fast Switching MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)		
30	0.008 at $V_{GS} = 10 \text{ V}$	18		
	0.011 at V _{GS} = 4.5 V	15		

FEATURES

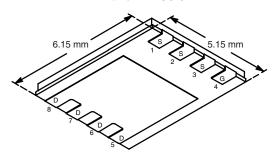
Halogen-free According to IEC 61249-2-21 Available



- PWM Optimized for High Efficiency
- New Low Thermal Resistance
- PowerPAK® Package with Low 1.07 mm Profile
 - 100 % R_g Tested

HALOGEN FREE

PowerPAK SO-8



Bottom View

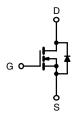
Ordering Information: Si7860DP-T1

Si7860DP-T1-E3 (Lead (Pb)-free)

Si7860DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

APPLICATIONS

- **Buck Converter**
 - High Side or Low Side
- Synchronous Rectifier
 - Secondary Rectifier



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unles	ss otherwise n	oted			
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V_{DS}	30		V	
Gate-Source Voltage		V_{GS}	± 20		V	
Continuous Drain Current /T = 150 °C\8	T _A = 25 °C	I _D	18	11		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		15	8		
Pulsed Drain Current		I _{DM}	± 50		Α	
Continuous Source Current (Diode Continuous) ^a		I _S	4.1	1.5		
Avalanche Current	L = 0.1 mH	I _{AS}	30			
Single Pulse Avalanche Energy	L = 0.1 IIII	E _{AS}	45		mJ	
Manianum Danian Dissinational	T _A = 25 °C	Pp	5	1.8	W	
Maximum Power Dissipation ^a	T _A = 70 °C		3.2	1.1		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150			
Soldering Recommendations (Peak Temperature) ^{b,c}			260		°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manifestore Investigate Ambient (MOCFFT)	t ≤ 10 s	R _{thJA}	20	25	°C/W
Maximum Junction-to-Ambient (MOSFET) ^a	Steady State		56	70	
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	1.8	2.3	

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Solder Profile (www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.

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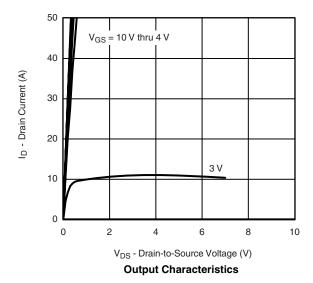
SPECIFICATIONS T _J = 25 °C	C, unless of	therwise noted					
Parameter	Symbol	Test Conditions M		Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.0		3.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valta da Dunio Comunist	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	0 V		1		
Zero Gate Voltage Drain Current		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$			5	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	40			Α	
Drain-Source On-State Resistance ^a	Ъ	V _{GS} = 10 V, I _D = 18 A		0.0066 0.008			
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 15 \text{ A}$		0.0090	0.011	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 18 A		60		S	
Diode Forward Voltage ^a	V_{SD}	I _S = 3 A, V _{GS} = 0 V		0.70	1.1	V	
Dynamic ^b	l I			<u>'</u>			
Total Gate Charge	Qg			13	18		
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 18 \text{ A}$		5		nC	
Gate-Drain Charge	Q_{gd}			4.0		1	
Gate Resistance	R_g		0.5	1.7	3.2	Ω	
Turn-On Delay Time	t _{d(on)}			18	27		
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		12	18		
Turn-Off Delay Time	t _{d(off)}	$t_{d(off)}$ $I_D \cong 1 \text{ A, } V_{GEN} = 10 \text{ V, } R_g = 6 \Omega$		46	70	ns	
Fall Time	t _f			19	30		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 3 A, dI/dt = 100 A/μs		40	70		

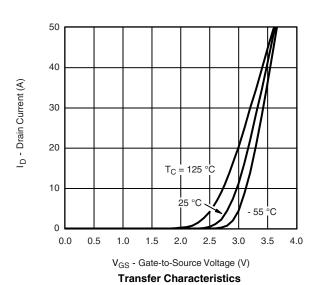
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

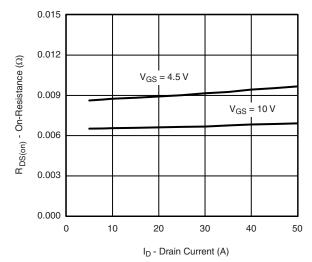




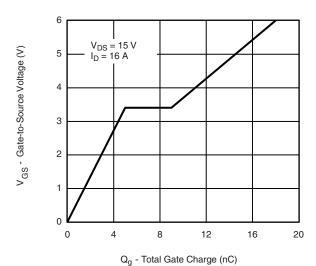




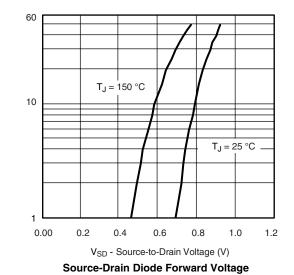
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On-Resistance vs. Drain Current



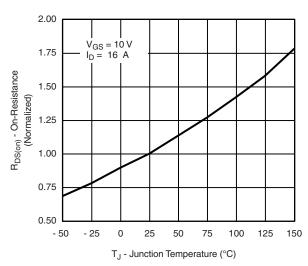
Gate Charge



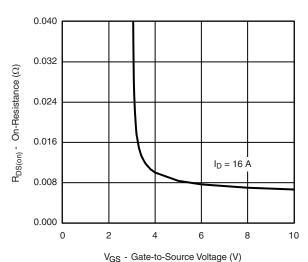
2500 2000 Ciss C - Capacitance (pF) 1500 1000 Coss 500 $\mathsf{C}_{\mathsf{rss}}$ 0 6 18 0 12 24 30

V_{DS} - Drain-to-Source Voltage (V)





On-Resistance vs. Junction Temperature



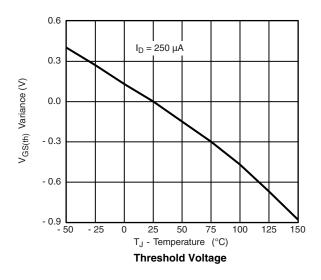
On-Resistance vs. Gate-to-Source Voltage

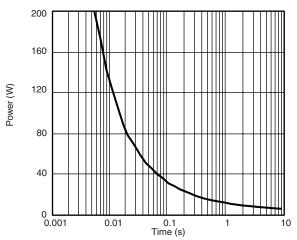
Is - Source Current (A)

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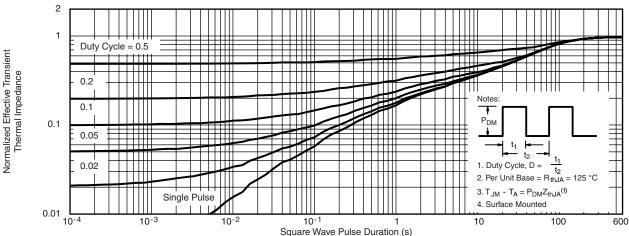
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

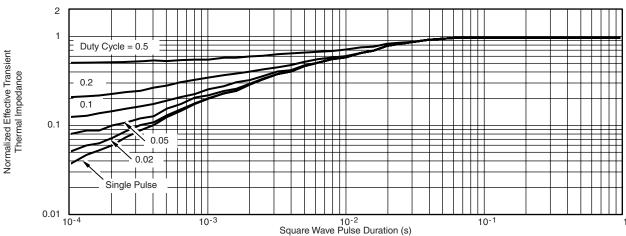




Single Pulse Power, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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